



Material Content Data Sheet



Sales Product Name				IDW32G65C5B		Issued		31. January 2019	
MA#				MA001675332					
Package				PG-TO247-3-41		Weight*		6045.17 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip_1	inorganic material	silicon	7440-21-3	0.873	0.01	0.01	144	144	
chip_2	inorganic material	silicon	7440-21-3	0.873	0.01	0.01	144	144	
leadframe	inorganic material	phosphorus	7723-14-0	0.159	0.00		26		
	non noble metal	iron	7439-89-6	0.530	0.01		88		
	non noble metal	copper	7440-50-8	529.068	8.75	8.76	87519	87633	
	non noble metal	aluminium	7429-90-5	1.801	0.03	0.03	298	298	
wire	non noble metal	aluminium	7429-90-5	1.801	0.03	0.03	298	298	
encapsulation	organic material	carbon black	1333-86-4	20.071	0.33		3320		
	plastics	epoxy resin	-	381.345	6.31		63083		
	inorganic material	silicondioxide	60676-86-0	1605.662	26.56	33.20	265611	332014	
leadfinish	non noble metal	tin	7440-31-5	31.874	0.53	0.53	5273	5273	
plating	non noble metal	nickel	7440-02-0	29.065	0.48	0.48	4808	4808	
solder	non noble metal	antimony	7440-36-0	0.136	0.00		23		
	noble metal	silver	7440-22-4	0.341	0.01		56		
	non noble metal	tin	7440-31-5	0.886	0.01	0.02	147	226	
heatspreader	inorganic material	phosphorus	7723-14-0	1.033	0.02		171		
	non noble metal	iron	7439-89-6	3.442	0.06		569		
	non noble metal	copper	7440-50-8	3438.006	56.88	56.96	568720	569460	
*deviation	< 10%			Sum in total:		100.00		1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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